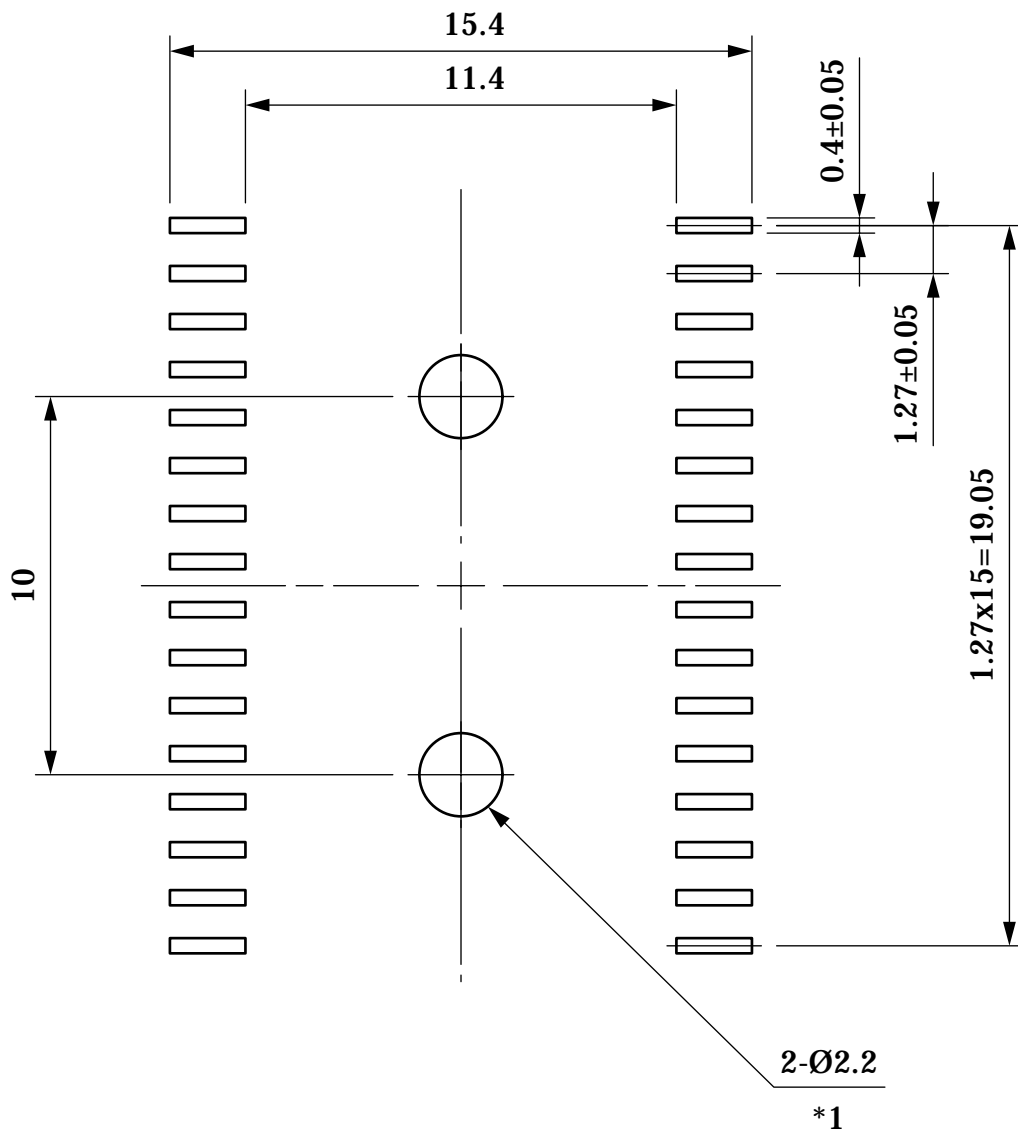


Recommended a Foot pattern of NSPACK32YU



NOTE:

- *1. Non-through hole is requested when using NSPACK32YU-SL type.
- * 2. Recommended foot pattern shown on above is for NSPACK soldering.
But please refer to IC package foot pattern recommended by IC manufacturer also, when the package is soldered on the same foot pattern.
- * 3. Tolerance: ±0.1

Part No.	NSPACK32YU	
IC package	Rectangle	
Pin count	32Pin	
Lead pitch	1.27mm	
Unit : mm	Design : M.M.	
TET TOKYO ELETECH CORP.		